

# DATA SHEET

**74F112**

Dual J-K negative edge-triggered flip-flop

Product specification

1990 Feb 09

IC15 Data Handbook

Philips  
Semiconductors



**PHILIPS**

**Dual J-K negative edge-triggered flip-flop****74F112****FEATURE**

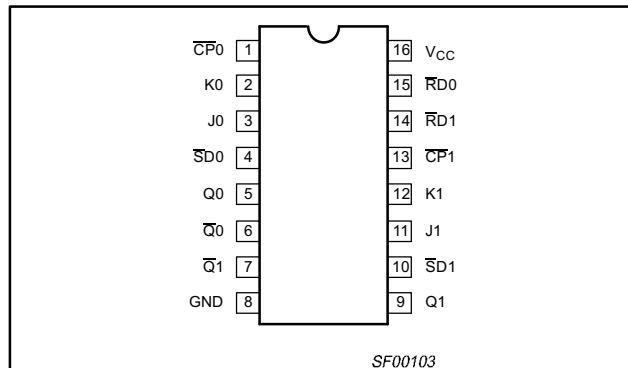
- Industrial temperature range available ( $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ )

**DESCRIPTION**

The 74F112, Dual Negative Edge-Triggered JK-Type Flip-Flop, feature individual J, K, Clock ( $\overline{\text{CP}}\text{n}$ ), Set ( $\overline{\text{SD}}$ ) and Reset ( $\overline{\text{RD}}$ ) inputs, true ( $\text{Qn}$ ) and complementary ( $\overline{\text{Qn}}$ ) outputs.

The  $\overline{\text{SD}}$  and  $\overline{\text{RD}}$  inputs, when Low, set or reset the outputs as shown in the Function Table, regardless of the level at the other inputs.

A High level on the clock ( $\overline{\text{CP}}\text{n}$ ) input enables the J and K inputs and data will be accepted. The logic levels at the J and K inputs may be allowed to change while the  $\overline{\text{CP}}\text{n}$  is High and flip-flop will perform according to the Function Table as long as minimum setup and hold times are observed. Output changes are initiated by the High-to-Low transition of the  $\overline{\text{CP}}\text{n}$ .

**PIN CONFIGURATION**

TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F112	100MHz	15mA

**ORDERING INFORMATION**

DESCRIPTION	ORDER CODE		PKG DWG #
	COMMERCIAL RANGE $V_{CC} = 5V \pm 10\%$ , $T_{amb} = 0^{\circ}\text{C}$ to $+70^{\circ}\text{C}$	INDUSTRIAL RANGE $V_{CC} = 5V \pm 10\%$ , $T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$	
16-pin plastic DIP	N74F112N	I74F112N	SOT38-4
16-pin plastic SO	N74F112D	I74F112D	SOT109-1

**INPUT AND OUTPUT LOADING AND FAN-OUT TABLE**

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
J0, J1	J inputs	1.0/1.0	20 $\mu\text{A}$ /0.6mA
K0, K1	K inputs	1.0/1.0	20 $\mu\text{A}$ /0.6mA
$\overline{\text{SD}}\text{0}, \overline{\text{SD}}\text{1}$	Set inputs (active Low)	1.0/5.0	20 $\mu\text{A}$ /3.0mA
$\overline{\text{RD}}\text{0}, \overline{\text{RD}}\text{1}$	Reset inputs (active Low)	1.0/5.0	20 $\mu\text{A}$ /3.0mA
$\overline{\text{CP}}\text{0}, \overline{\text{CP}}\text{1}$	Clock Pulse input (active falling edge)	1.0/4.0	20 $\mu\text{A}$ /2.4mA
Q0, $\overline{\text{Q}}\text{0}; \text{Q1}, \overline{\text{Q}}\text{1}$	Data outputs	50/33	1.0mA/20mA

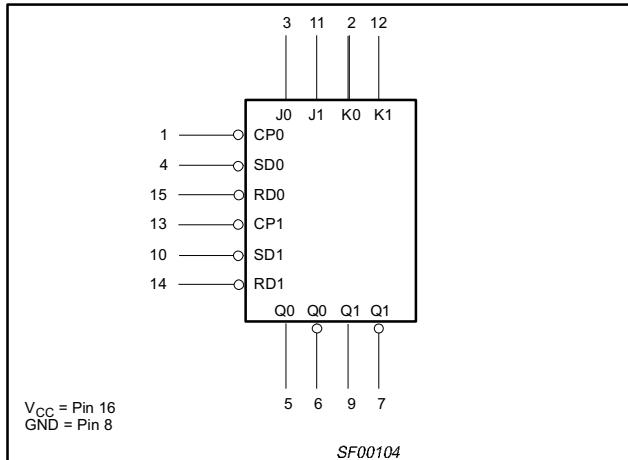
**NOTE:**

One (1.0) FAST unit load is defined as: 20 $\mu\text{A}$  in the High state and 0.6mA in the Low state.

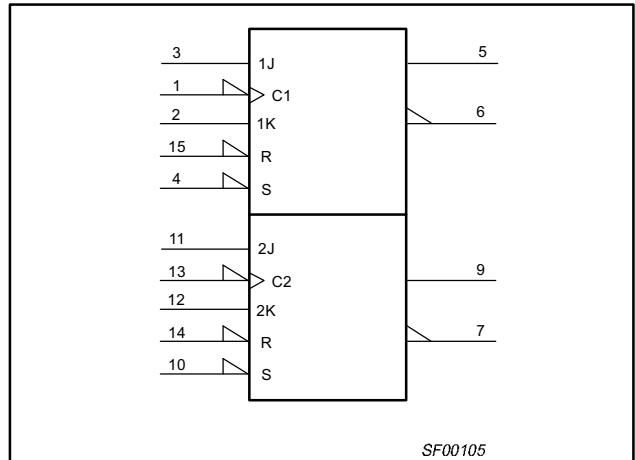
## Dual J-K negative edge-triggered flip-flop

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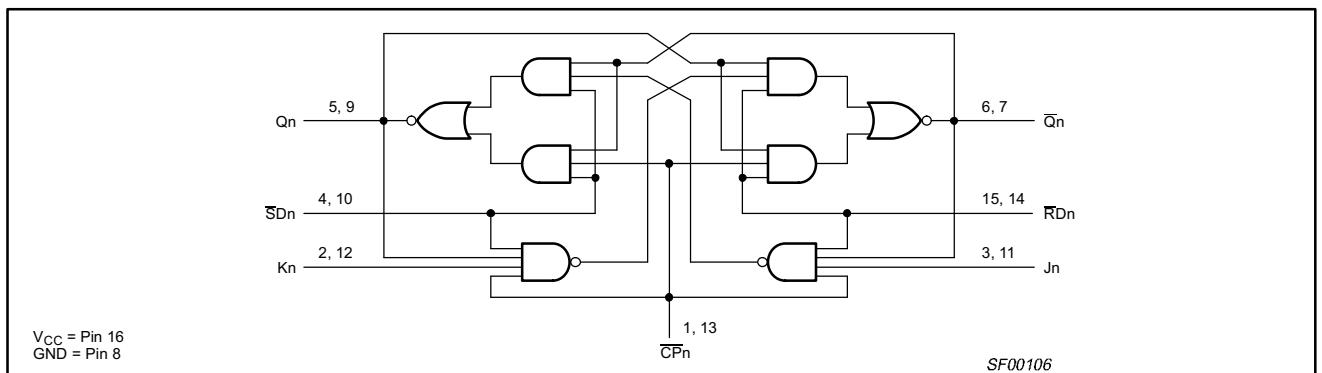
## LOGIC SYMBOL



## IEC/IEEE SYMBOL



## LOGIC DIAGRAM



## FUNCTION TABLE

INPUTS					OUTPUTS		OPERATING MODE
$\overline{SD}$	$\overline{RD}$	$\overline{CP}$	J	K	Q	$\overline{Q}$	
L	H	X	X	X	H	L	Asynchronous Set
H	L	X	X	X	L	H	Asynchronous Reset
L	L	X	X	X	H*	H*	Undetermined *
H	H	↓	h	h	$\overline{q}$	q	Toggle
H	H	↓	l	h	L	H	Load "0" (Reset)
H	H	↓	h	l	H	L	Load "1" (Set)
H	H	↓	l	l	q	$\overline{q}$	Hold "no change"
H	H	H	X	X	Q	$\overline{Q}$	Hold "no change"

H = High voltage level

h = High voltage level one setup time prior to High-to-Low clock transition

L = Low voltage level

I = Low voltage level one setup time prior to High-to-Low clock transition

q = Lower case letters indicate the state of the reference output prior to the High-to-Low clock transition

X = Don't care

↓ = High-to-Low clock transition

\* = Both outputs will be High while both  $\overline{SD}$  and  $\overline{RD}$  are Low, but the output states are unpredictable if  $\overline{SD}$  and  $\overline{RD}$  go High simultaneously.

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**ABSOLUTE MAXIMUM RATINGS**

(Operation beyond the limits set forth in this table may impair the useful life of the device.  
Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
$V_{CC}$	Supply voltage	-0.5 to +7.0	V
$V_{IN}$	Input voltage	-0.5 to +7.0	V
$I_{IN}$	Input current	-30 to +5	mA
$V_{OUT}$	Voltage applied to output in High output state	-0.5 to $V_{CC}$	V
$I_{OUT}$	Current applied to output in Low output state	40	mA
$T_{amb}$	Operating free-air temperature range	Commercial range	0 to +70
		Industrial range	-40 to +85
$T_{stg}$	Storage temperature range	-65 to +150	°C

**RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	LIMITS			UNIT
		MIN	NOM	MAX	
$V_{CC}$	Supply voltage	4.5	5.0	5.5	V
$V_{IH}$	High-level input voltage	2.0			V
$V_{IL}$	Low-level input voltage			0.8	V
$I_{IK}$	Input clamp current			-18	mA
$I_{OH}$	High-level output current			-1	mA
$I_{OL}$	Low-level output current			20	mA
$T_{amb}$	Operating free-air temperature range	Commercial range	0	+70	°C
		Industrial range	-40	+85	°C

**DC ELECTRICAL CHARACTERISTICS**

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER	TEST CONDITIONS <sup>1</sup>		LIMITS			UNIT
		MIN	TYP <sup>2</sup>	MAX			
$V_{OH}$	High-level output voltage	$V_{CC} = \text{MIN}$ , $V_{IL} = \text{MAX}$	$\pm 10\% V_{CC}$	2.5			V
		$V_{IH} = \text{MIN}$ , $I_{OH} = \text{MAX}$	$\pm 5\% V_{CC}$	2.7	3.4		
$V_{OL}$	Low-level output voltage	$V_{CC} = \text{MIN}$ , $V_{IL} = \text{MAX}$	$\pm 10\% V_{CC}$		0.35	0.50	V
		$V_{IH} = \text{MIN}$ , $I_{OL} = \text{MAX}$	$\pm 5\% V_{CC}$		0.35	0.50	
$V_{IK}$	Input clamp voltage	$V_{CC} = \text{MIN}$ , $I_I = I_{IK}$			-0.73	-1.2	V
$I_I$	Input current at maximum input voltage	$V_{CC} = \text{MAX}$ , $V_I = 7.0\text{V}$				100	μA
$I_{IH}$	High-level input current	$V_{CC} = \text{MAX}$ , $V_I = 2.7\text{V}$				20	μA
$I_{IL}$	Low-level input current	Jn, Kn				-0.6	mA
		CPn				-2.4	mA
		SDn, RDn				-3.0	mA
$I_{OS}$	Short-circuit output current <sup>3</sup>	$V_{CC} = \text{MAX}$	-60		-150		mA
$I_{CC}$	Supply current (total) <sup>4</sup>	$V_{CC} = \text{MAX}$		15	21		mA

**NOTES:**

- For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- All typical values are at  $V_{CC} = 5\text{V}$ ,  $T_{amb} = 25^\circ\text{C}$ .
- Not more than one output should be shorted at a time. For testing  $I_{OS}$ , the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests,  $I_{OS}$  tests should be performed last.
- Measure  $I_{CC}$  with the clock input grounded and all outputs open, with the Q and  $\bar{Q}$  outputs High in turn.

## Dual J-K negative edge-triggered flip-flop

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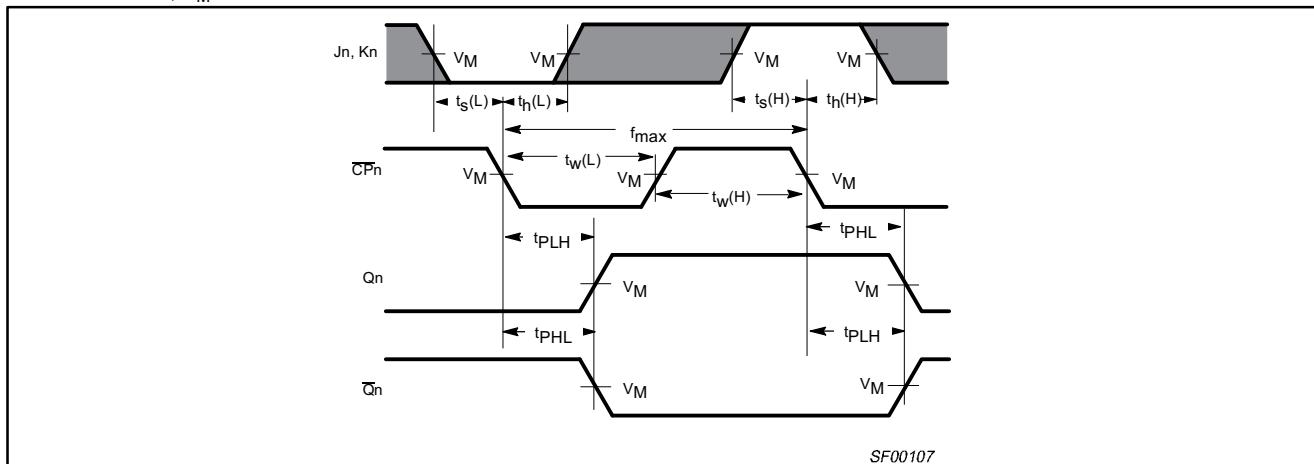
## AC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITION	LIMITS						UNIT	
			$V_{CC} = +5.0V$ $T_{amb} = +25^{\circ}C$ $C_L = 50pF$ $R_L = 500\Omega$			$V_{CC} = +5.0V \pm 10\%$ $T_{amb} = 0^{\circ}C$ to $+70^{\circ}C$ $C_L = 50pF$ $R_L = 500\Omega$		$V_{CC} = +5.0V \pm 10\%$ $T_{amb} = -40^{\circ}C$ to $+85^{\circ}C$ $C_L = 50pF$ $R_L = 500\Omega$		
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$f_{MAX}$	Maximum clock frequency	Waveform 1	85	100		80		80		MHz
$t_{PLH}$ $t_{PHL}$	Propagation delay $\overline{CP}$ to $Q_n$ or $\overline{Q}_n$	Waveform 1	2.0 2.0	5.0 5.0	6.5 6.5	2.0 2.0	7.5 7.5	2.0 2.0	7.5 7.5	ns
$t_{PLH}$ $t_{PHL}$	Propagation delay $\overline{SD}_n$ , $\overline{RD}$ to $Q_n$ or $\overline{Q}_n$	Waveform 2,3	2.0 2.0	4.5 4.5	6.5 6.5	2.0 2.0	7.5 7.5	1.5 1.5	7.5 7.5	ns

## AC SETUP REQUIREMENTS

SYMBOL	PARAMETER	TEST CONDITION	LIMITS						UNIT	
			$V_{CC} = +5.0V$ $T_{amb} = +25^{\circ}C$ $C_L = 50pF$ $R_L = 500\Omega$			$V_{CC} = +5.0V \pm 10\%$ $T_{amb} = 0^{\circ}C$ to $+70^{\circ}C$ $C_L = 50pF$ $R_L = 500\Omega$		$V_{CC} = +5.0V \pm 10\%$ $T_{amb} = -40^{\circ}C$ to $+85^{\circ}C$ $C_L = 50pF$ $R_L = 500\Omega$		
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$t_{S(H)}$ $t_{S(L)}$	Setup time, High or Low $J_n$ , $K_n$ to $\overline{CP}$	Waveform 1	4.0 3.5			5.0 4.0		5.0 4.0		ns
$t_h(H)$ $t_h(L)$	Hold time, High or Low $J_n$ , $K_n$ to $\overline{CP}$	Waveform 1	0.0 0.0			0.0 0.0		0.0 0.0		ns
$t_w(H)$ $t_w(L)$	$\overline{CP}$ Pulse width High or Low	Waveform 1	4.5 4.5			5.0 5.0		5.0 5.0		ns
$t_w(L)$	$\overline{SD}_n$ , $\overline{RD}$ Pulse width Low	Waveform 2,3	4.5			5.0		5.0		ns
$t_{REC}$	Recovery time $\overline{SD}_n$ , $\overline{RD}$ to $CP$	Waveform 2,3	4.5			5.0		5.0		ns

## AC WAVEFORMS

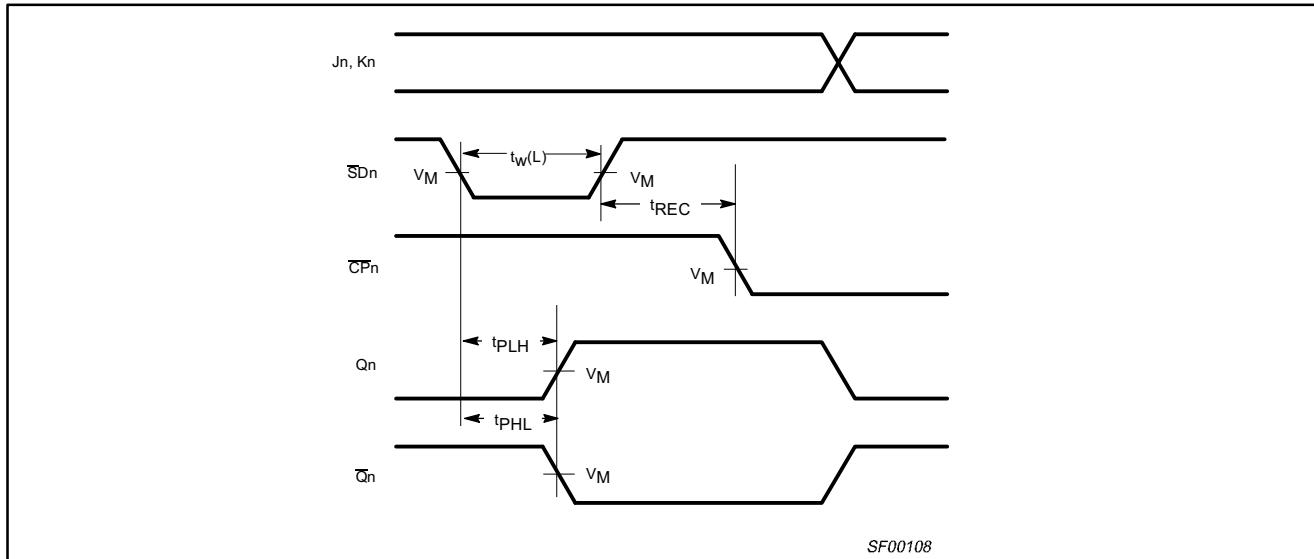
For all waveforms,  $V_M = 1.5V$ .

The shaded areas indicate when the input is permitted to change for predictable output performance.

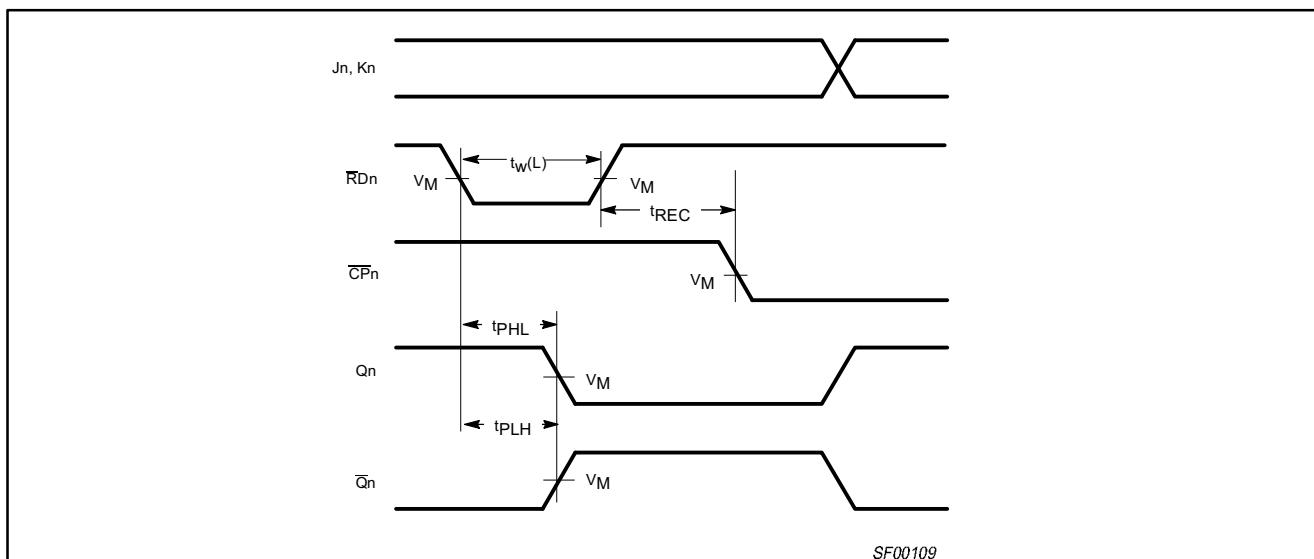
**Waveform 1. Propagation Delay for Data to Output, Data Setup Time and Hold Times, and Clock Pulse Width**

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Waveform 2. Propagation Delay for Set to Output, Set Pulse Width, and Recovery Time for Set to Clock

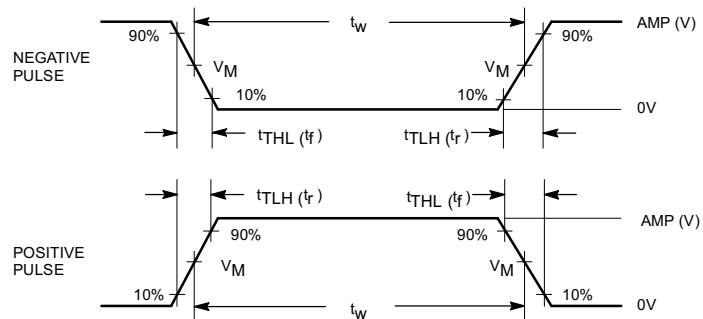
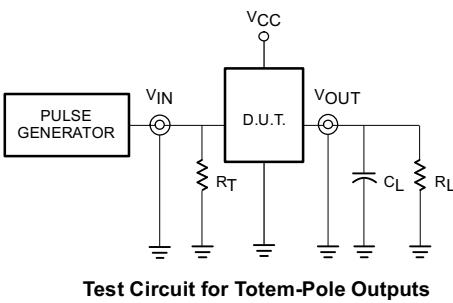


Waveform 3. Propagation Delay for Reset to Output, Reset Pulse Width, and Recovery Time for Reset to Clock

## Dual J-K negative edge-triggered flip-flop

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## TEST CIRCUIT AND WAVEFORMS

**DEFINITIONS:**

- $R_L$  = Load resistor;  
see AC ELECTRICAL CHARACTERISTICS for value.
- $C_L$  = Load capacitance includes jig and probe capacitance;  
see AC ELECTRICAL CHARACTERISTICS for value.
- $R_T$  = Termination resistance should be equal to  $Z_{OUT}$  of  
pulse generators.

**Input Pulse Definition**

family	INPUT PULSE REQUIREMENTS					
	amplitude	$V_M$	rep. rate	$t_w$	$t_{TLH}$	$t_{THL}$
74F	3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns

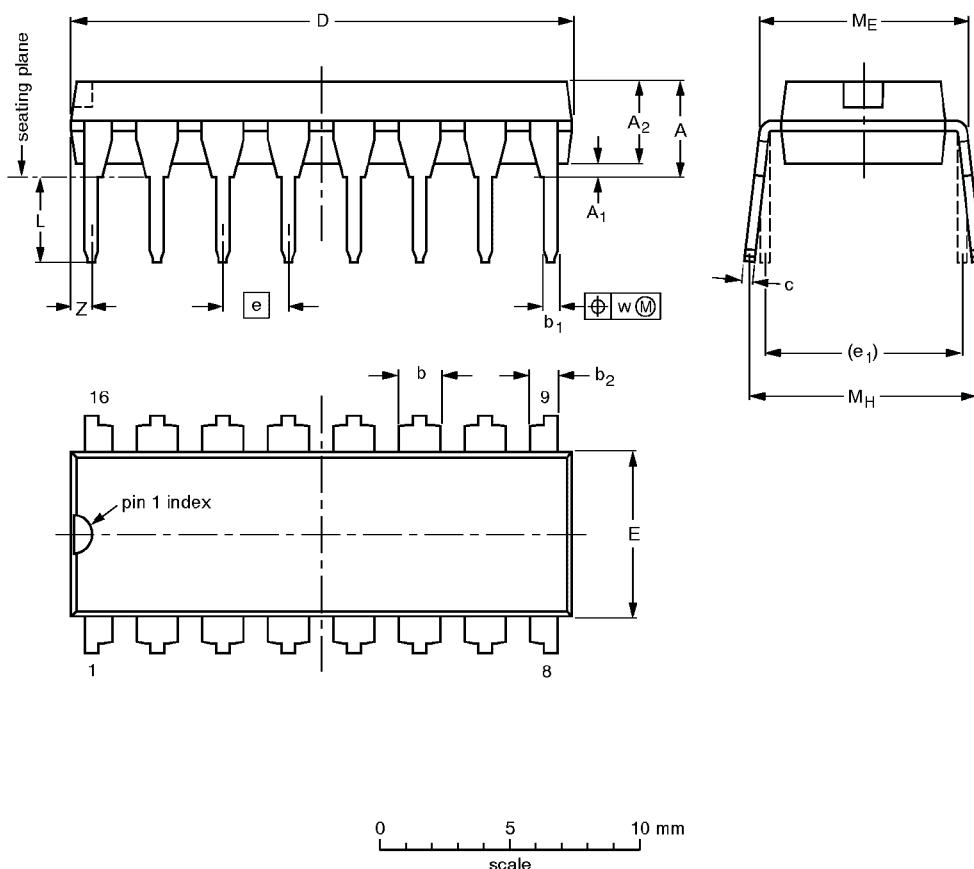
SF00006

## Dual J-K negative edge-triggered flip-flop

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DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



## DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	b <sub>2</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	e <sub>1</sub>	L	M <sub>E</sub>	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

## Note

- Plastic or metal protrusions of 0.25 mm maximum per side are not included.

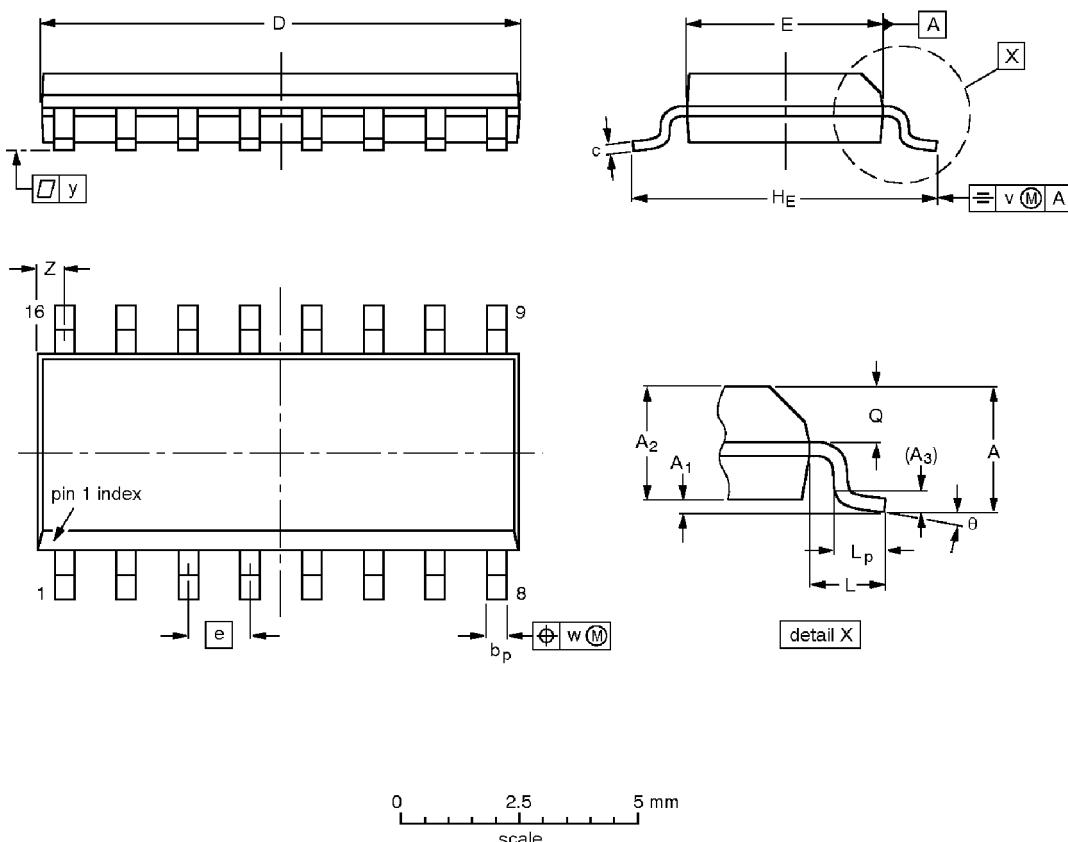
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT38-4						92-11-17 95-01-14

## Dual J-K negative edge-triggered flip-flop

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SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



## DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	1.75 0.10	0.25 1.25	1.45	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069 0.004	0.010 0.049	0.057	0.01	0.019 0.014	0.0100 0.0075	0.39 0.38	0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	

## Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT109-1	076E07S	MS-012AC				95-01-23 97-05-22

## Dual J-K negative edge-triggered flip-flop

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**Data sheet status**

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

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**Limiting values definition** — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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